



# PAL20R8 Family

## 24-Pin TTL Programmable Array Logic

### DISTINCTIVE CHARACTERISTICS

- As fast as 5 ns maximum propagation delay
- Popular 24-pin architectures: 20L8, 20R8, 20R6, 20R4
- Programmable replacement for high-speed TTL logic
- Power-up reset for initialization
- Extensive third-party software and programmer support through FusionPLD partners
- 24-pin SKINNYDIP and 28-pin PLCC packages save space

### GENERAL DESCRIPTION

The PAL20R8 Family (PAL20L8, PAL20R8, PAL20R6, PAL20R4) includes the PAL20R8-5 Series which is ideal for high-performance applications. The PAL20R8 Family is provided in the standard 24-pin DIP and 28-pin PLCC pinouts.

The family utilizes Advanced Micro Devices' advanced trench-isolated bipolar process and fuse-link technology. The devices provide user programmable logic for replacing conventional SSI/LSI gates and flip-flops at a reduced chip cost.

The family allows the systems engineer to implement the design on-chip, by opening fuse links to configure AND and OR gates within the device, according to the desired logic function. Complex interconnections between gates, which previously required time-consuming layout, are lifted from the PC board and placed on silicon, where they can be easily modified during prototyping or production.

The PAL device implements the familiar Boolean logic transfer function, the sum of products. The PAL device is a programmable AND array driving a fixed OR array. The AND array is programmed to create custom product terms, while the OR array sums selected terms at the outputs.

In addition, the PAL device provides the following options:

- Variable input/output pin ratio
- Programmable three-state outputs
- Registers with feedback

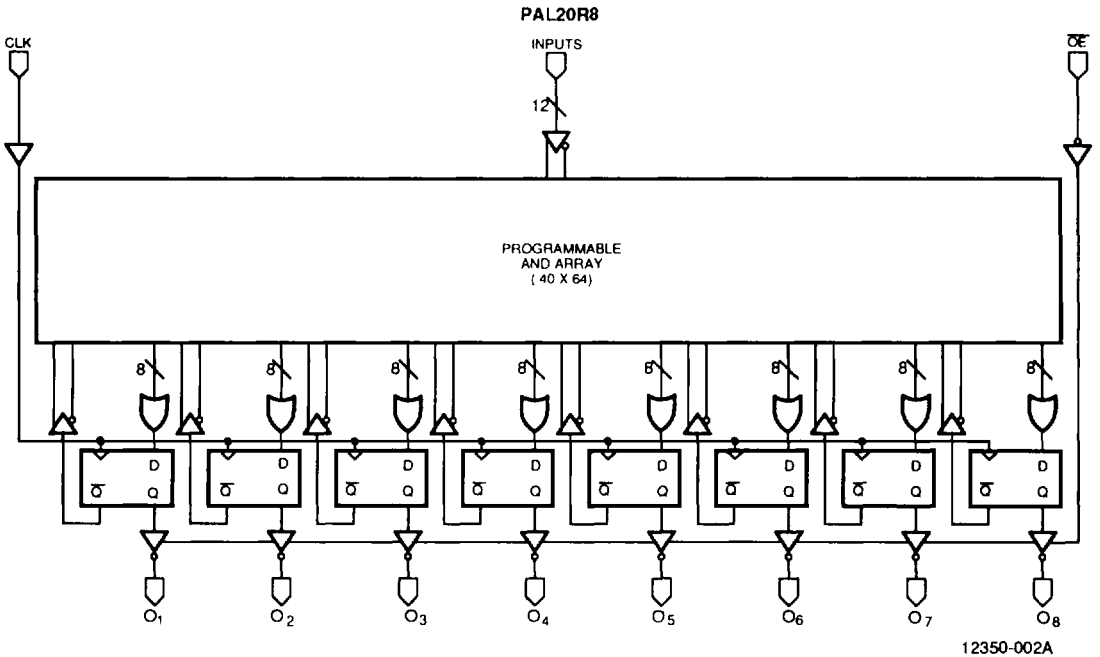
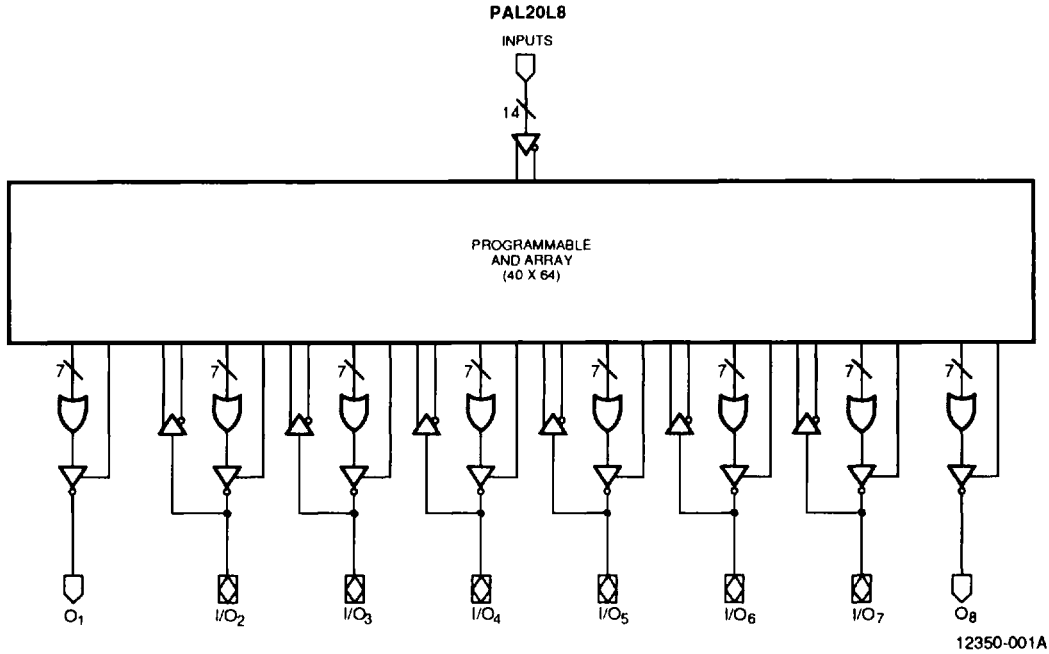
Product terms with all connections opened assume the logical HIGH state; product terms connected to both true and complement of any single input assume the logical LOW state. Registers consist of D-type flip-flops that are loaded on the LOW-to-HIGH transition of the clock. Unused input pins should be tied to Vcc or GND.

AMD's FusionPLD program allows PAL20R8 Family designs to be implemented using a wide variety of popular industry-standard design tools. By working closely with the FusionPLD partners, AMD certifies that the tools provide accurate, quality support. By ensuring that third-party tools are available, costs are lowered because a designer does not have to buy a complete set of new tools for each device. The FusionPLD program also greatly reduces design time since a designer can use a tool that is already installed and familiar. Please refer to the PLD Software Reference Guide for certified development systems and the Programmer Reference Guide for approved programmers.

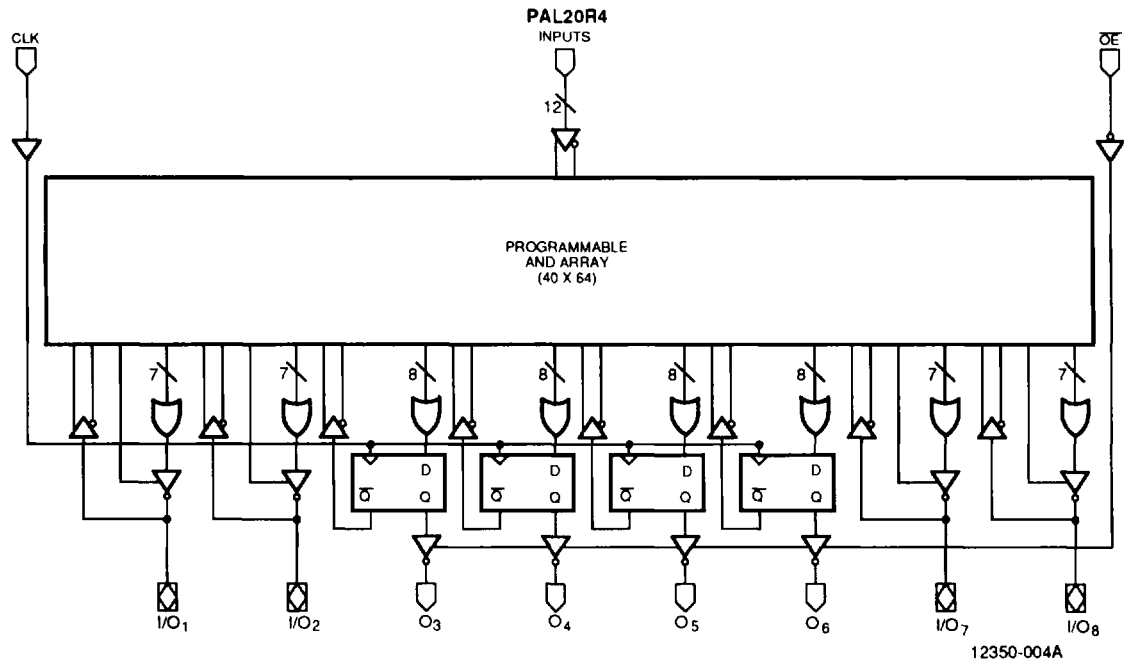
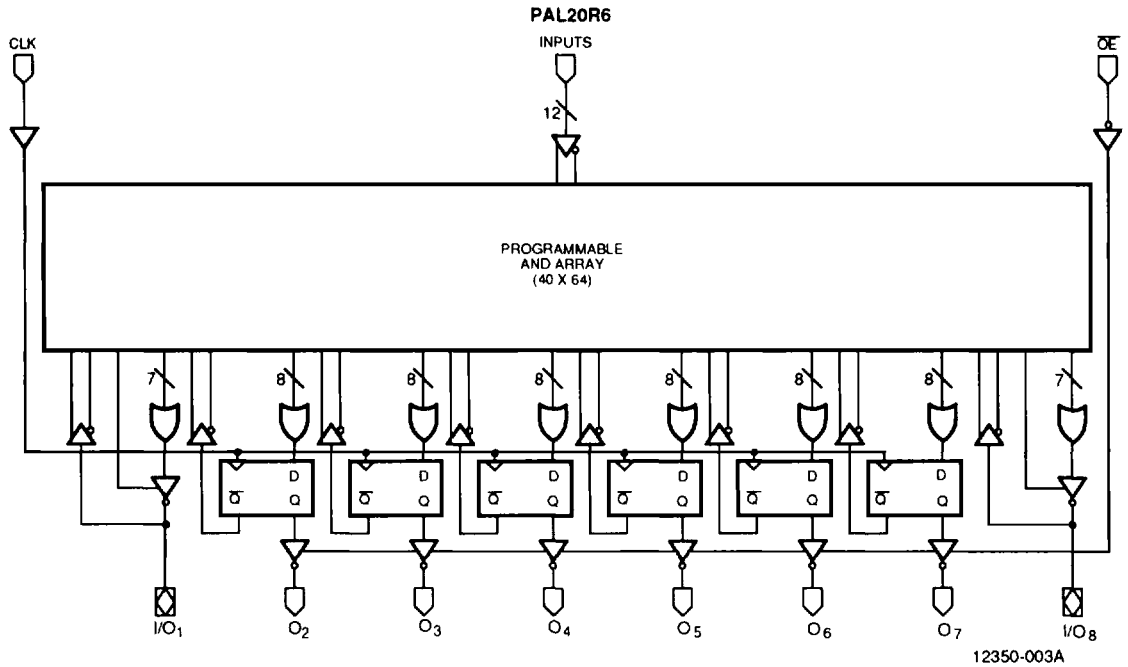
### PRODUCT SELECTOR GUIDE

Device	Dedicated Inputs	Outputs	Product Terms/ Output	Feedback	Enable
PAL20L8	14	6 comb. 2 comb.	7 7	I/O -	prog. prog.
PAL20R8	12	8 reg.	8	reg.	pin
PAL20R6	12	6 reg. 2 comb.	8 7	reg. I/O	pin prog.
PAL20R4	12	4 reg. 4 comb.	8 7	reg. I/O	pin prog.

BLOCK DIAGRAMS



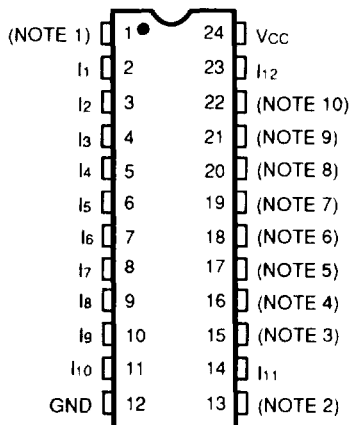
**BLOCK DIAGRAMS**



CONNECTION DIAGRAMS

Top View

SKINNYDIP/FLATPACK



12350-005A

Note:

Pin 1 is marked for orientation.

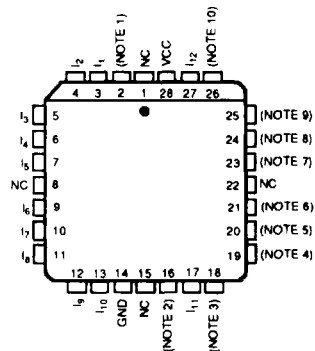
Note	20L8	20R8	20R6	20R4
1	I <sub>0</sub>	CLK	CLK	CLK
2	I <sub>13</sub>	$\overline{O}E$	$\overline{O}E$	$\overline{O}E$
3	O <sub>1</sub>	O <sub>1</sub>	I/O <sub>1</sub>	I/O <sub>1</sub>
4	I/O <sub>2</sub>	O <sub>2</sub>	O <sub>2</sub>	I/O <sub>2</sub>
5	I/O <sub>3</sub>	O <sub>3</sub>	O <sub>3</sub>	O <sub>3</sub>
6	I/O <sub>4</sub>	O <sub>4</sub>	O <sub>4</sub>	O <sub>4</sub>
7	I/O <sub>5</sub>	O <sub>5</sub>	O <sub>5</sub>	O <sub>5</sub>
8	I/O <sub>6</sub>	O <sub>6</sub>	O <sub>6</sub>	O <sub>6</sub>
9	I/O <sub>7</sub>	O <sub>7</sub>	O <sub>7</sub>	I/O <sub>7</sub>
10	O <sub>8</sub>	O <sub>8</sub>	I/O <sub>8</sub>	I/O <sub>8</sub>

PIN DESIGNATIONS

- CLK Clock
- GND Ground
- I Input
- I/O Input/Output
- NC No Connect
- O Output
- $\overline{O}E$  Output Enable
- Vcc Supply Voltage

PLCC/LCC

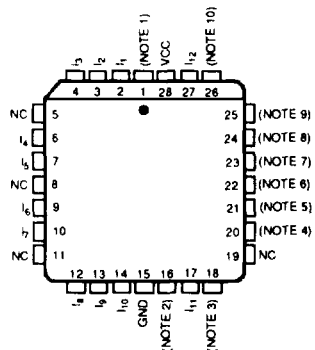
JEDEC Applies to -.5, -.7(-.12/10 mil),  
-10(-.15 mil), B-2 Series Only



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PLCC

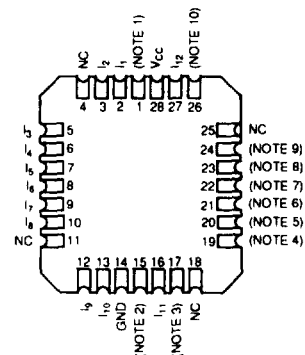
Applies to B and A Series Only



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LCC

Applies to B and A Series Only

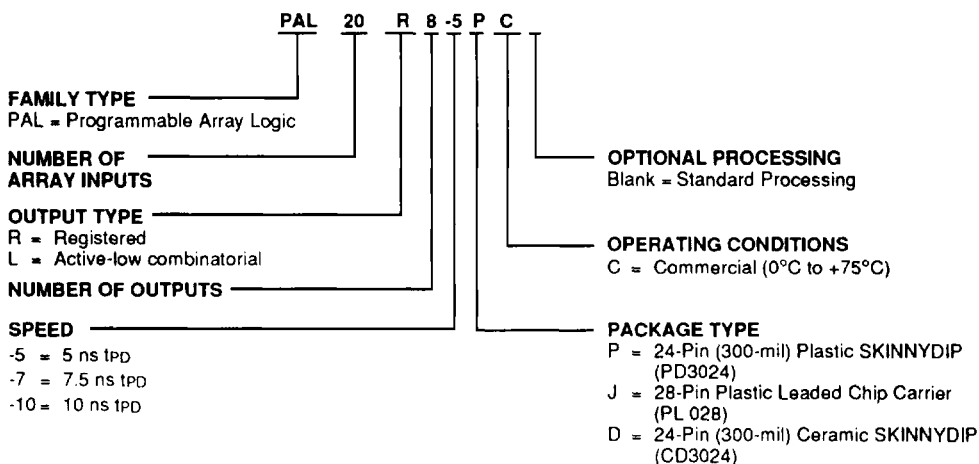


16490A-002A

## ORDERING INFORMATION

### Commercial Products

AMD programmable logic products for commercial applications are available with several ordering options. The order number (Valid Combination) is formed by a combination of:



Valid Combinations	
PAL20L8-5	PC, JC
PAL20R8-5	
PAL20R6-5	
PAL20R4-5	
PAL20L8-7	PC, JC, DC
PAL20L8-10	
PAL20R8-7	
PAL20R8-10	
PAL20R6-7	
PAL20R6-10	
PAL20R4-7	
PAL20R4-10	

#### Valid Combinations

The Valid Combinations table lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, and to check on newly released combinations.

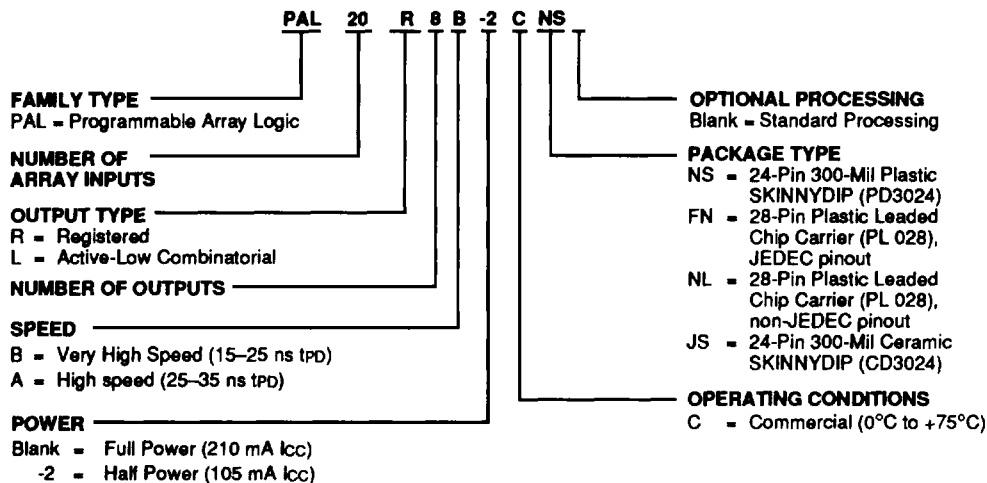
**Note:** Marked with AMD logo.



## ORDERING INFORMATION

### Commercial Products (MMI Marking Only)

AMD programmable logic products for commercial applications are available with several ordering options. The order number (Valid Combination) is formed by a combination of:



Valid Combinations		
PAL20L8	B-2	CNS, CFN, CJS
PAL20R8	B, A	CNS, CNL, CJS
PAL20R6		
PAL20R4		

#### Valid Combinations

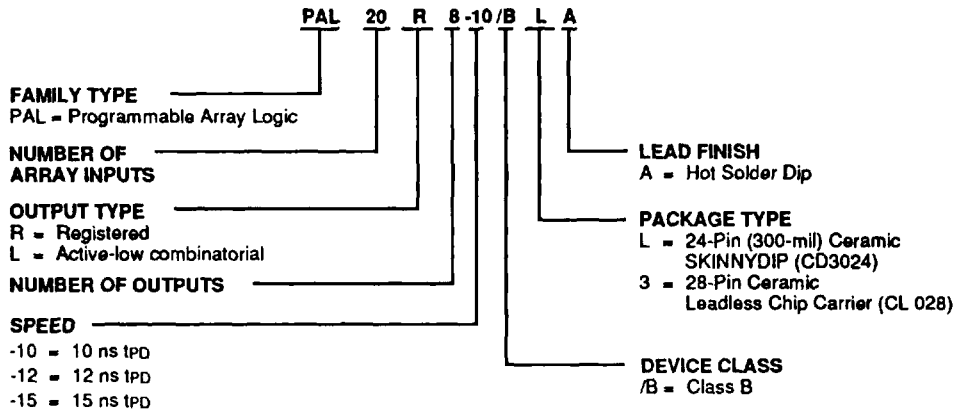
The Valid Combinations table lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, and to check on newly released combinations.

**Note:** Marked with MMI logo.

**ORDERING INFORMATION**

**APL Products**

AMD programmable logic products for Aerospace and Defense applications are available with several ordering options. APL (Approved Products List) products are fully compliant with MIL-STD-883 requirements. The order number (Valid Combination) is formed by a combination of:



Valid Combinations		
PAL20L8		
PAL20R8	-10, -12, -15	/BLA, /B3A
PAL20R6		
PAL20R4		

**Valid Combinations**

The Valid Combinations table lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

**Note:** Marked with AMD logo.

**Group A Tests**

Group A Tests consist of Subgroups: 1, 2, 3, 7, 8, 9, 10, 11.

**Military Burn-In**

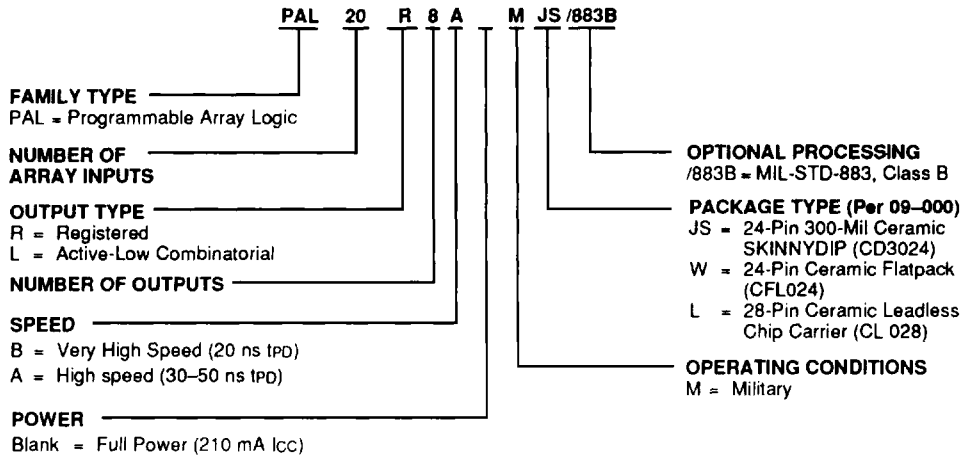
Military burn-in is in accordance with the current revision of MIL-STD-883, Test Methods 1015, Conditions A through E. Test conditions are selected at AMD's option.



## ORDERING INFORMATION

### APL Products (MMI Marking Only)

AMD programmable logic products for Aerospace and Defense applications are available with several ordering options. APL (Approved Products List) products are fully compliant with MIL-STD-883 requirements. The order number (Valid Combination) is formed by a combination of:



Valid Combinations		
PAL20L8	B, A	MJS/883B, MW/883B, ML/883B
PAL20R8		
PAL20R6		
PAL20R4		

#### Valid Combinations

The Valid Combinations table lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, and to check on newly released combinations.

**Note:** Marked with MMI logo.

#### Group A Tests

Group A Tests consist of Subgroups: 1, 2, 3, 7, 8, 9, 10, 11.

#### Military Burn-In

Military burn-in is in accordance with the current revision of MIL-STD-883, Test Methods 1015, Conditions A through E. Test conditions are selected at AMD's option.



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## FUNCTIONAL DESCRIPTION

### Standard 24-Pin PAL Family

The standard 24-pin PAL family is comprised of four different devices, including both registered and combinatorial devices. All parts are produced with a fuse link at each input to the AND gate array, and connections may be selectively removed by applying appropriate voltages to the circuit. Using any of a number of development packages, these products can be rapidly programmed to any customized pattern. Extra test words are pre-programmed during manufacturing to ensure extremely high field programming yields, and provide extra test paths to achieve excellent parametric correlation.

### Variable Input/Output Pin Ratio

The registered devices have twelve dedicated input lines, and each combinatorial output is an I/O pin. The PAL20L8 has fourteen dedicated input lines, and only six of the eight combinatorial outputs are I/O pins. Buffers for device inputs have complementary outputs to provide user-programmable input signal polarity. Unused input pins should be tied to V<sub>CC</sub> or GND.

### Programmable Three-State Outputs

Each output has a three-state output buffer with three-state control. On combinatorial outputs, a product term controls the buffer, allowing enable and disable to be a function of any product of device inputs or output feedback. The combinatorial output provides a bidirectional I/O pin, and may be configured as a dedicated input if the buffer is always disabled. On registered outputs, an input pin controls the enabling of the three-state outputs.

### Registers with Feedback

Registered outputs are provided for data storage and synchronization. Registers are composed of D-type flip-flops that are loaded on the LOW-to-HIGH transition of the clock input.

### Power-Up Reset

All flip-flops power-up to a logic LOW for predictable system initialization. Outputs of the PAL20R8 Family will be HIGH due to the active-low outputs. The V<sub>CC</sub> rise must be monotonic and the reset delay time is 1000 ns maximum.

### Register Preload

The register on the PAL20R8 Family can be preloaded from the output pins to facilitate functional testing of complex state machine designs. This feature allows direct loading of arbitrary states, making it unnecessary to cycle through long test vector sequences to reach a desired state. In addition, transitions from illegal states can be verified by loading illegal states and observing proper recovery.

### Security Fuse

After programming and verification, a PAL20R8 Family design can be secured by programming the security fuse. Once programmed, this fuse defeats readback of the internal programmed pattern by a device programmer, securing proprietary designs from competitors. When the security fuse is programmed, the array will read as if every fuse is intact.

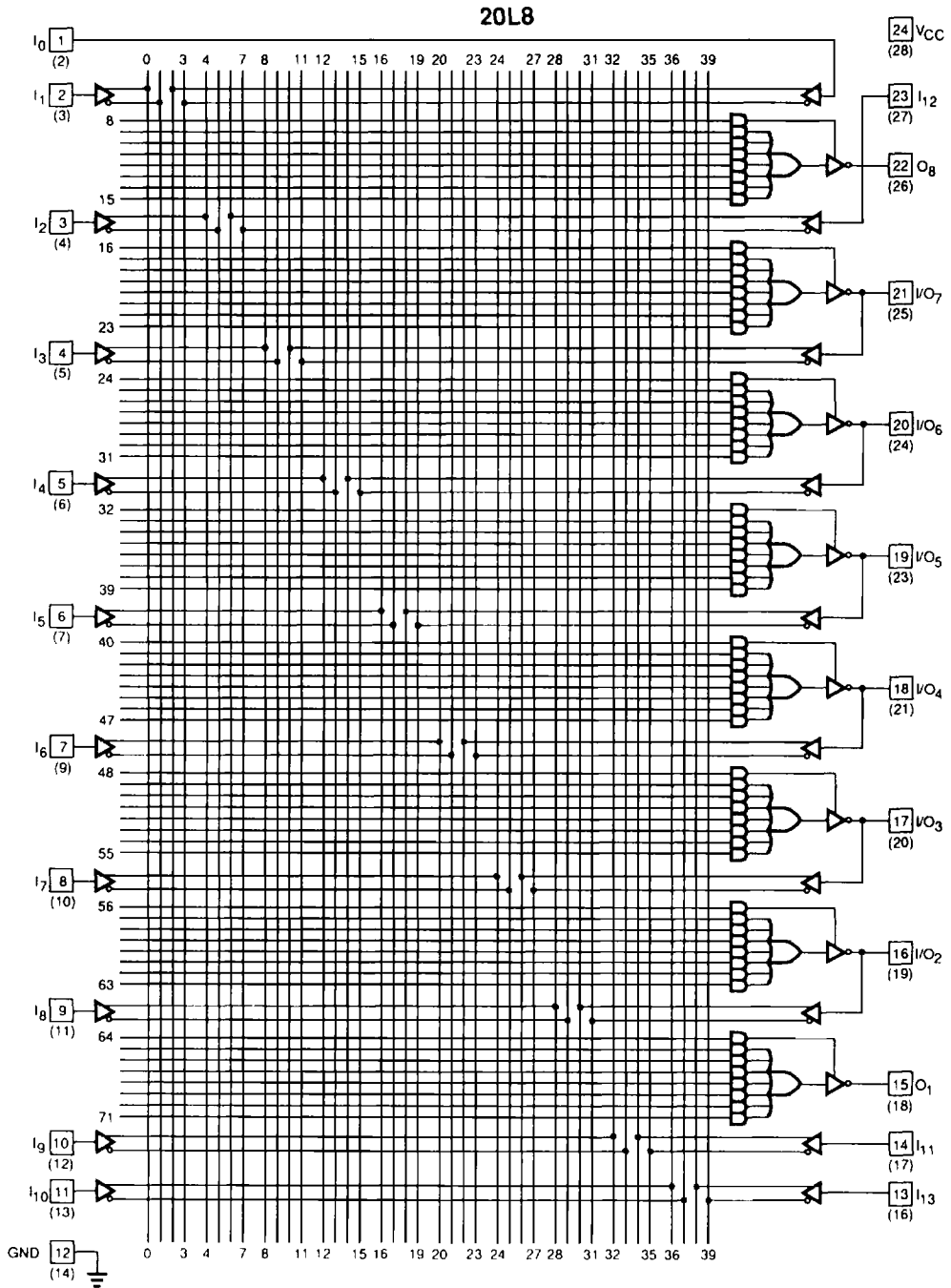
### Quality and Testability

The PAL20R8 Family offers a very high level of built-in quality. Extra programmable fuses provide a means of verifying performance of all AC and DC parameters. In addition, this verifies complete programmability and functionality of the device to provide the highest programming yields and post-programming functional yields in the industry.

### Technology

The high-speed PAL20R8 Family is fabricated with AMD's advanced trench-isolated bipolar process. This process reduces parasitic capacitances and minimum geometries to provide higher performance. The array connections are formed with proven TiW fuses.

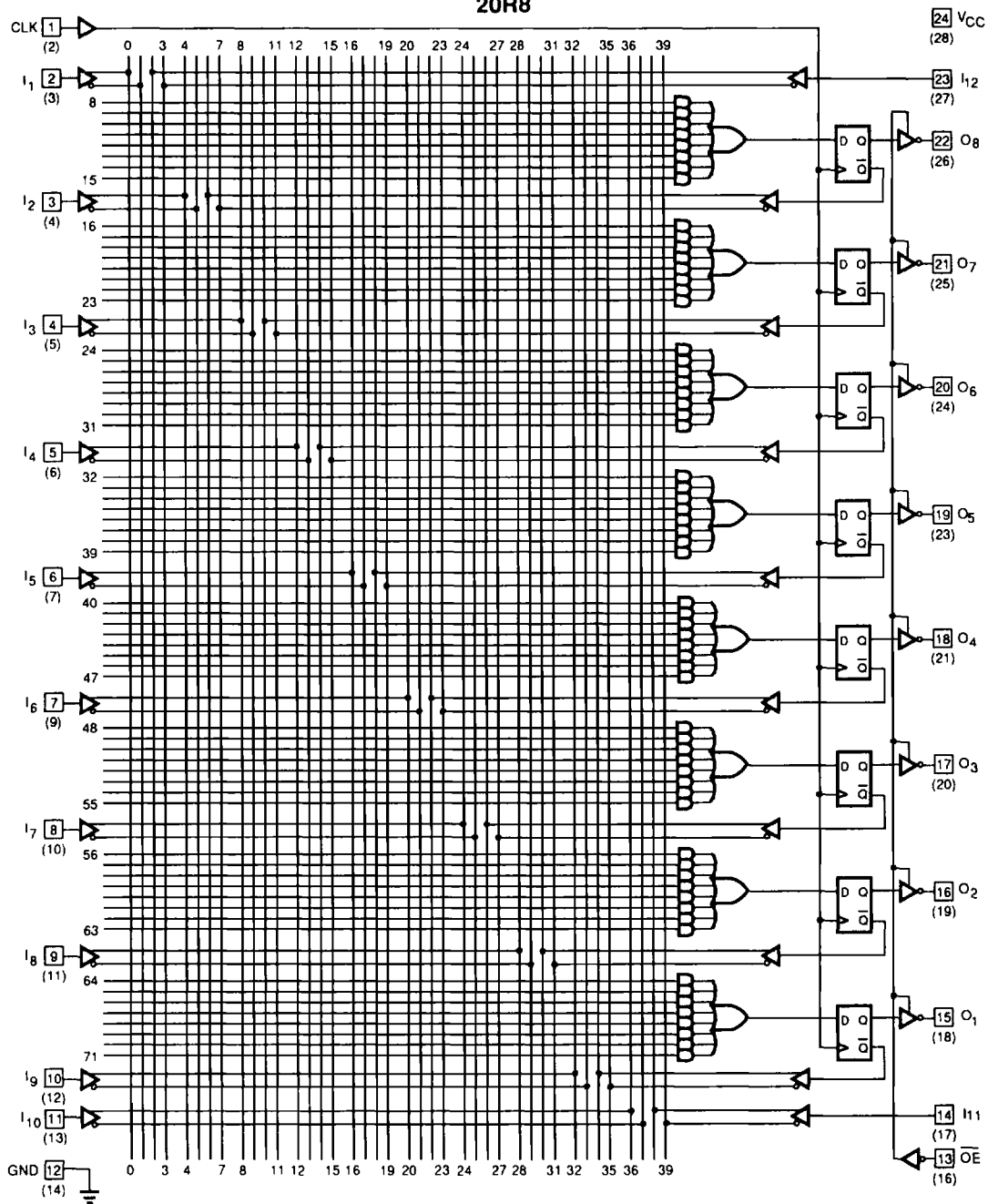
**LOGIC DIAGRAM**  
**DIP (PLCC) Pinouts**



12350-007A

**LOGIC DIAGRAM**  
**DIP (PLCC) Pinouts**

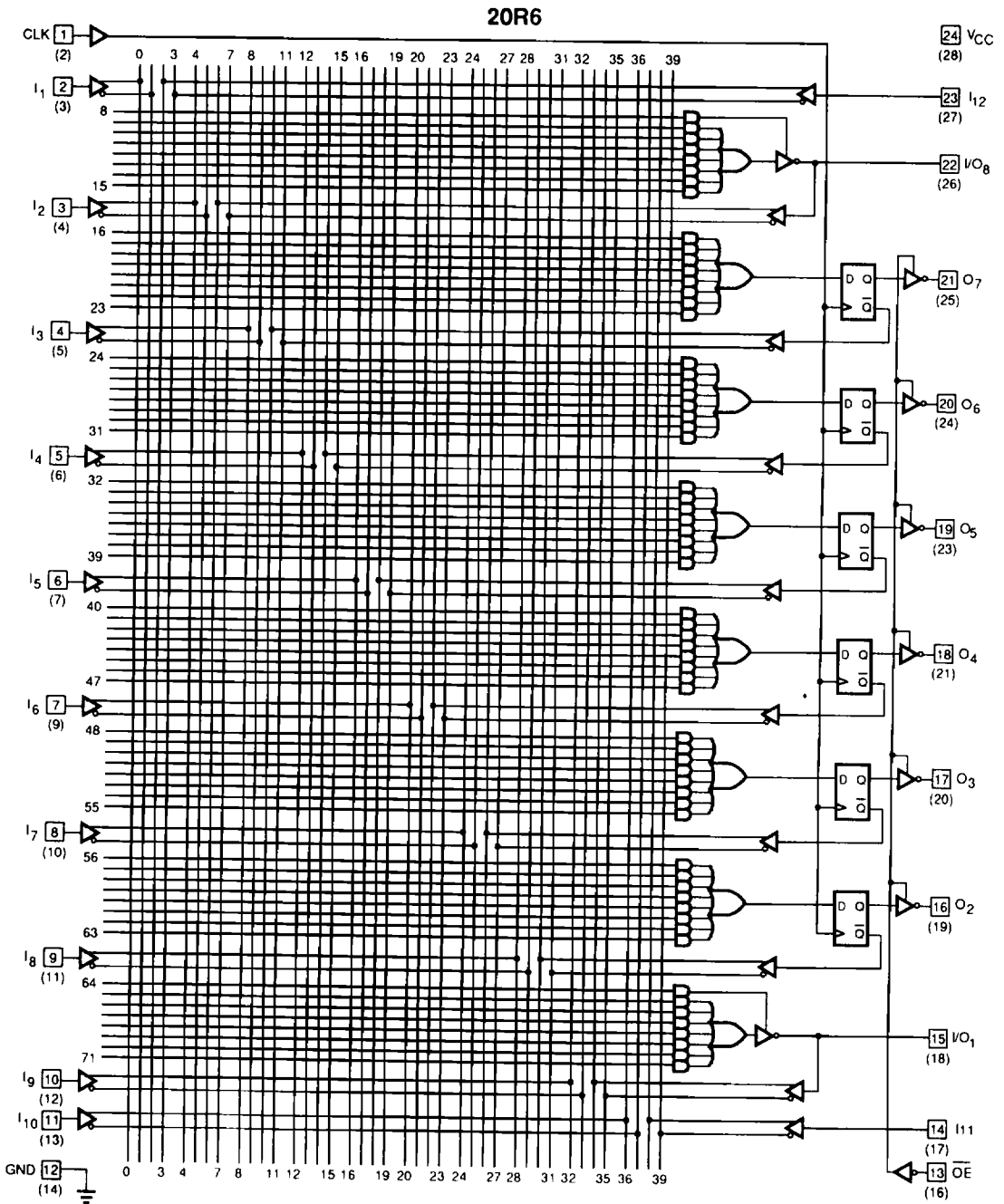
**20R8**



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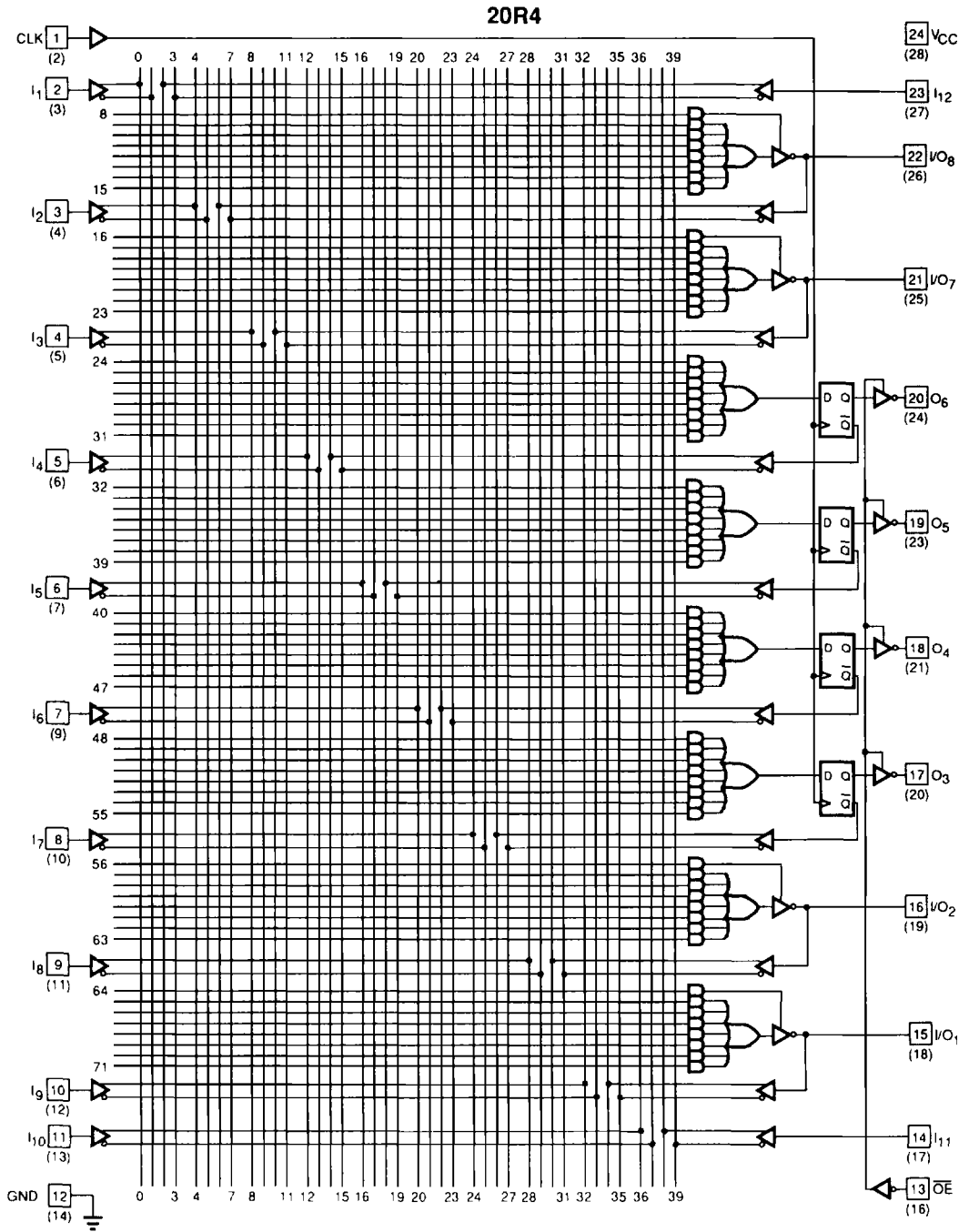


# LOGIC DIAGRAM DIP (PLCC) Pinouts



12350-009A

**LOGIC DIAGRAM**  
**DIP (PLCC) Pinouts**



12350-010A

## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.2 V to $V_{CC} + 0.5$ V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC} + 0.5$ V
Static Discharge Voltage	2001 V

## OPERATING RANGES

### Commercial (C) Devices

Ambient Temperature ( $T_A$ ) Operating in Free Air	0°C to 75°C
Supply Voltage ( $V_{CC}$ ) with Respect to Ground	4.75 V to 5.25 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

## DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -3.2$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 24$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18$ mA, $V_{CC} = \text{Min.}$		-1.2	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7$ V, $V_{CC} = \text{Max.}$ (Note 2)		25	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4$ V, $V_{CC} = \text{Max.}$ (Note 2)		-250	$\mu\text{A}$
$I_I$	Maximum Input Current	$V_{IN} = 5.5$ V, $V_{CC} = \text{Max.}$		1	mA
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.7$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		100	$\mu\text{A}$
$I_{OZL}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		-100	$\mu\text{A}$
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5$ V, $V_{CC} = \text{Max.}$ (Note 3)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0$ V, Outputs Open ( $I_{OUT} = 0$ mA) $V_{CC} = \text{Max.}$		210	mA

### Notes:

- These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
- I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OZL}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
- Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.

**CAPACITANCE (Note 1)**

Parameter Symbol	Parameter Description		Test Conditions		Typ.	Unit
C <sub>IN</sub>	Input Capacitance	CLK, $\overline{OE}$	V <sub>IN</sub> = 2.0 V	V <sub>CC</sub> = 5.0 V T <sub>A</sub> = +25°C f = 1 MHz	8	pF
		I <sub>1</sub> - I <sub>12</sub>			5	
C <sub>OUT</sub>	Output Capacitance		V <sub>OUT</sub> = 2.0 V		8	

**Note:**

1. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

**SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 2)**

Parameter Symbol	Parameter Description		Min. (Note 3)	Max.	Unit		
t <sub>PD</sub>	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4	1	5	ns	
t <sub>S</sub>	Setup Time from Input or Feedback to Clock		20R8, 20R6, 20R4	4.5		ns	
t <sub>H</sub>	Hold Time			0		ns	
t <sub>CO</sub>	Clock to Output			1	4	ns	
t <sub>SKWR</sub>	Skew Between Registered Outputs (Note 4)				1	ns	
t <sub>WL</sub>	Clock Width	LOW		4		ns	
		HIGH		4		ns	
f <sub>MAX</sub>	Maximum Frequency (Note 5)	External Feedback		1/(t <sub>S</sub> + t <sub>CO</sub> )	117		MHz
		Internal Feedback (f <sub>CNT</sub> )			125		MHz
		No Feedback		1/(t <sub>WH</sub> + t <sub>WL</sub> )	125		MHz
t <sub>PZX</sub>	$\overline{OE}$ to Output Enable				1	6.5	ns
t <sub>XPZ</sub>	$\overline{OE}$ to Output Disable			1	5	ns	
t <sub>EA</sub>	Input to Output Enable Using Product Term Control		20L8, 20R6, 20R4	2	6.5	ns	
t <sub>ER</sub>	Input to Output Disable Using Product Term Control			2	5	ns	

**Notes:**

2. See Switching Test Circuit for test conditions.
3. Output delay minimums are measured under best-case conditions.
4. Skew testing takes into account pattern and switching direction differences between outputs that have equal loading.
5. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where the frequency may be affected.

## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.2 V to $V_{CC} + 0.5$ V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC} + 0.5$ V
Static Discharge Voltage	2001 V

## OPERATING RANGES

### Commercial (C) Devices

Ambient Temperature ( $T_A$ ) Operating in Free Air	0°C to +75°C
Supply Voltage ( $V_{CC}$ ) With Respect to Ground	+4.75 V to +5.25 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

## DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -3.2$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 24$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18$ mA, $V_{CC} = \text{Min.}$		-1.2	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7$ V, $V_{CC} = \text{Max.}$ (Note 2)		25	$\mu$ A
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4$ V, $V_{CC} = \text{Max.}$ (Note 2)		-250	$\mu$ A
$I_I$	Maximum Input Current	$V_{IN} = 5.5$ V, $V_{CC} = \text{Max.}$		1	mA
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.7$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		100	$\mu$ A
$I_{OZL}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		-100	$\mu$ A
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5$ V, $V_{CC} = \text{Max.}$ (Note 3)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0$ V, Outputs Open ( $I_{OUT} = 0$ mA) $V_{CC} = \text{Max.}$		210	mA

### Notes:

1. These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
2. I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OZL}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
3. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.



### CAPACITANCE (Note 1)

Parameter Symbol	Parameter Description	Test Conditions		Typ.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 2.0 V	V <sub>CC</sub> = 5.0 V T <sub>A</sub> = +25°C	7	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 2.0 V	f = 1 MHz	8	

**Note:**

1. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

### SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 2)

Parameter Symbol	Parameter Description		Min. (Note 3)	Max.	Unit		
t <sub>PD</sub>	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4	3	7.5	ns	
		1 Output Switching		3	7		
t <sub>S</sub>	Setup Time from Input or Feedback to Clock		20R8, 20R6, 20R4	7		ns	
t <sub>H</sub>	Hold Time			0		ns	
t <sub>CO</sub>	Clock to Output			3	6.5	ns	
t <sub>SKEW</sub>	Skew Between Registered Outputs (Note 4)				1	ns	
t <sub>WL</sub>	Clock Width	LOW		5		ns	
t <sub>WH</sub>		HIGH		5		ns	
f <sub>MAX</sub>	Maximum Frequency (Note 5)	External Feedback		1/(t <sub>S</sub> + t <sub>CO</sub> )	74		MHz
		Internal Feedback (f <sub>CNT</sub> )			100		MHz
		No Feedback		1/(t <sub>WH</sub> + t <sub>WL</sub> )	100		MHz
t <sub>PXZ</sub>	$\overline{OE}$ to Output Enable			3	8	ns	
t <sub>XPZ</sub>	$\overline{OE}$ to Output Disable		3	8	ns		
t <sub>EA</sub>	Input to Output Enable Using Product Term Control		20L8, 20R6,	3	10	ns	
t <sub>ER</sub>	Input to Output Disable Using Product Term Control		20R4	3	10	ns	

**Notes:**

2. See Switching Test Circuit for test conditions.
3. Output delay minimums are measured under best-case conditions.
4. Skew is measured with all outputs switching in the same direction.
5. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where the frequency may be affected.



## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-0.5 V to $V_{CC} + 0.5$ V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC}$ Max.
DC Input Current	-30 mA to +5 mA

## OPERATING RANGES

### Commercial (C) Devices

Ambient Temperature ( $T_A$ ) Operating in Free Air	0°C to +75°C
Supply Voltage ( $V_{CC}$ ) with Respect to Ground	+4.75 V to +5.25 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

## DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -3.2$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 24$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18$ mA, $V_{CC} = \text{Min.}$		-1.5	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7$ V, $V_{CC} = \text{Max.}$ (Note 2)		25	$\mu$ A
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4$ V, $V_{CC} = \text{Max.}$ (Note 2)		-250	$\mu$ A
$I_I$	Maximum Input Current	$V_{IN} = 5.5$ V, $V_{CC} = \text{Max.}$		100	$\mu$ A
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.7$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		100	$\mu$ A
$I_{OZL}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		-100	$\mu$ A
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5$ V, $V_{CC} = \text{Max.}$ (Note 3)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0$ V, Outputs Open ( $I_{OUT} = 0$ mA) $V_{CC} = \text{Max.}$		210	mA

### Notes:

- These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
- I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OZL}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
- Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.

**CAPACITANCE (Note 1)**

Parameter Symbol	Parameter Description	Test Conditions			Typ.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 2.0 V	V <sub>CC</sub> = 5.0 V T <sub>A</sub> = 25°C	CLK, $\overline{OE}$	12	pF
				Other Inputs	7	
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 2.0 V	f = 1 MHz	Outputs	8	

**Note:**

1. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

**SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 2)**

Parameter Symbol	Parameter Description		Min. (Note 3)	Max.	Unit		
t <sub>PD</sub>	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4	3	10	ns	
t <sub>S</sub>	Setup Time from Input or Feedback to Clock		20R8, 20R6, 20R4	10		ns	
t <sub>H</sub>	Hold Time			0		ns	
t <sub>CO</sub>	Clock to Output			2	8	ns	
t <sub>WL</sub>	Clock Width	LOW		7		ns	
		HIGH		7		ns	
f <sub>MAX</sub>	Maximum Frequency (Note 5)	External Feedback		1/(t <sub>S</sub> + t <sub>CO</sub> )	55.5		MHz
		Internal Feedback (f <sub>CNT</sub> )		58.8		MHz	
		No Feedback		1/(t <sub>WH</sub> + t <sub>WL</sub> )	71.4		MHz
t <sub>PZX</sub>	$\overline{OE}$ to Output Enable				1	10	ns
t <sub>PXZ</sub>	$\overline{OE}$ to Output Disable				1	10	ns
t <sub>EA</sub>	Input to Output Enable Using Product Term Control		20L8, 20R6,	3	10	ns	
t <sub>ER</sub>	Input to Output Disable Using Product Term Control		20R4	3	10	ns	

**Notes:**

2. See Switching Test Circuit for test conditions.
3. Output delay minimums are measured under best-case conditions.
4. Calculated from measured f<sub>MAX</sub> internal.
5. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where the frequency may be affected.

## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.5 V to $V_{CC} + 0.5$ V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC} + 0.5$ V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

## OPERATING RANGES

### Commercial (C) Devices

Ambient Temperature ( $T_A$ )	0°C to +75°C
Operating in Free Air	
Supply Voltage ( $V_{CC}$ ) with Respect to Ground	+4.75 V to +5.25 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

## DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -3.2$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 24$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18$ mA, $V_{CC} = \text{Min.}$		-1.5	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7$ V, $V_{CC} = \text{Max.}$ (Note 2)		25	$\mu$ A
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4$ V, $V_{CC} = \text{Max.}$ (Note 2)		-250	$\mu$ A
$I_I$	Maximum Input Current	$V_{IN} = 5.5$ V, $V_{CC} = \text{Max.}$		100	$\mu$ A
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.7$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		100	$\mu$ A
$I_{OLZ}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		-100	$\mu$ A
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5$ V, $V_{CC} = \text{Max.}$ (Note 3)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0$ V, Outputs Open ( $I_{OUT} = 0$ mA) $V_{CC} = \text{Max.}$		210	mA

### Notes:

1. These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
2. I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OLZ}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
3. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.

**SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 1)**

Parameter Symbol	Parameter Description			Min.	Max.	Unit	
$t_{PD}$	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4		15	ns	
$t_s$	Setup Time from Input or Feedback to Clock			15		ns	
$t_H$	Hold Time			0		ns	
$t_{CO}$	Clock to Output or Feedback		20R8, 20R6, 20R4		12	ns	
$t_{WL}$	Clock Width	LOW		10		ns	
$t_{WH}$		HIGH		12		ns	
$f_{MAX}$	Maximum Frequency (Note 2)	External Feedback		$1/(t_s + t_{CO})$	37		MHz
		No Feedback		$1/(t_{WH} + t_{WL})$	45		MHz
$t_{PZX}$	$\overline{OE}$ to Output Enable				15	ns	
$t_{PXZ}$	$\overline{OE}$ to Output Disable				12	ns	
$t_{EA}$	Input to Output Enable Using Product Term Control		20L8, 20R6,		18	ns	
$t_{ER}$	Input to Output Disable Using Product Term Control		20R4		15	ns	

**Notes:**

1. See Switching Test Circuit for test conditions.
2. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.

**ABSOLUTE MAXIMUM RATINGS**

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.5 V to $V_{CC} + 0.5$ V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC} + 0.5$ V

**OPERATING RANGES**
**Commercial (C) Devices**

Ambient Temperature ( $T_A$ )	0°C to +75°C
Operating in Free Air	
Supply Voltage ( $V_{CC}$ ) with Respect to Ground	+4.75 V to +5.25 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

**DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified**

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -3.2$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 24$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18$ mA, $V_{CC} = \text{Min.}$		-1.5	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7$ V, $V_{CC} = \text{Max.}$ (Note 2)		25	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4$ V, $V_{CC} = \text{Max.}$ (Note 2)		-250	$\mu\text{A}$
$I_I$	Maximum Input Current	$V_{IN} = 5.5$ V, $V_{CC} = \text{Max.}$		100	$\mu\text{A}$
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.7$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		100	$\mu\text{A}$
$I_{OZL}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		-100	$\mu\text{A}$
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5$ V, $V_{CC} = \text{Max.}$ (Note 3)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0$ V, Outputs Open ( $I_{OUT} = 0$ mA) $V_{CC} = \text{Max.}$		105	mA

**Notes:**

- These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
- I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OZL}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
- Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.

**SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 1)**

Parameter Symbol	Parameter Description		Min.	Max.	Unit
t <sub>PD</sub>	Input or Feedback to Combinatorial Output			25	ns
t <sub>s</sub>	Setup Time from Input or Feedback to Clock		25		ns
t <sub>H</sub>	Hold Time		0		ns
t <sub>CO</sub>	Clock to Output			15	ns
t <sub>WL</sub>	Clock Width	LOW	15		ns
t <sub>WH</sub>		HIGH	15		ns
f <sub>MAX</sub>	Maximum Frequency (Note 3)	External Feedback	1/(t <sub>s</sub> + t <sub>CO</sub> )		MHz
		Internal Feedback (f <sub>CNT</sub> )		28.5	MHz
		No Feedback	1/(t <sub>WH</sub> + t <sub>WL</sub> )		33.3
t <sub>PZx</sub>	$\overline{OE}$ to Output Enable			20	ns
t <sub>PxZ</sub>	$\overline{OE}$ to Output Disable			20	ns
t <sub>EA</sub>	Input to Output Enable Using Product Term Control			25	ns
t <sub>ER</sub>	Input to Output Disable Using Product Term Control			25	ns

**Notes:**

1. See Switching Test Circuit for test conditions.
2. Calculated from measured f<sub>MAX</sub> internal.
3. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.

### ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.5 V to $V_{CC} + 0.5$ V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC} + 0.5$ V

### OPERATING RANGES

#### Commercial (C) Devices

Ambient Temperature ( $T_A$ ) Operating in Free Air	0°C to +75°C
Supply Voltage ( $V_{CC}$ ) with Respect to Ground	+4.75 V to +5.25 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

### DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -3.2$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 24$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18$ mA, $V_{CC} = \text{Min.}$		-1.5	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7$ V, $V_{CC} = \text{Max.}$ (Note 2)		25	$\mu$ A
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4$ V, $V_{CC} = \text{Max.}$ (Note 2)		-250	$\mu$ A
$I_I$	Maximum Input Current	$V_{IN} = 5.5$ V, $V_{CC} = \text{Max.}$		100	$\mu$ A
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.7$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		100	$\mu$ A
$I_{OLZ}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 2)		-100	$\mu$ A
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5$ V, $V_{CC} = \text{Max.}$ (Note 3)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0$ V, Outputs Open ( $I_{OUT} = 0$ mA) $V_{CC} = \text{Max.}$		210	mA

#### Notes:

1. These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
2. I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OLZ}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
3. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.



**SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 1)**

Parameter Symbol	Parameter Description		Min.	Max.	Unit	
t <sub>PD</sub>	Input or Feedback to Combinatorial Output			25	ns	
t <sub>s</sub>	Setup Time from Input or Feedback to Clock		25		ns	
t <sub>H</sub>	Hold Time		0		ns	
t <sub>CO</sub>	Clock to Output			15	ns	
t <sub>WL</sub>	Clock Width	LOW	15		ns	
t <sub>WH</sub>		HIGH	15		ns	
f <sub>MAX</sub>	Maximum Frequency (Note 3)	External Feedback	1/(t <sub>s</sub> + t <sub>CO</sub> )		MHz	
		Internal Feedback (f <sub>CNT</sub> )			28.5	MHz
		No Feedback	1/(t <sub>WH</sub> + t <sub>WL</sub> )		33	MHz
t <sub>PZX</sub>	$\overline{OE}$ to Output Enable			20	ns	
t <sub>PXZ</sub>	$\overline{OE}$ to Output Disable			20	ns	
t <sub>EA</sub>	Input to Output Enable Using Product Term Control		20L8, 20R6,	25	ns	
t <sub>ER</sub>	Input to Output Disable Using Product Term Control		20R4	25	ns	

**Notes:**

1. See Switching Test Circuit for test conditions.
2. Calculated from measured f<sub>MAX</sub> internal.
3. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.

## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature With Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.2 V to $V_{CC} + 0.5$ V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC} + 0.5$ V
Static Discharge Voltage	2001 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ. Absolute Maximum Ratings are for system design reference; parameters given are not tested.

## OPERATING RANGES

### Military (M) Devices (Note 1)

Operating Case ( $T_c$ ) Temperature	-55°C to +125°C
Supply Voltage ( $V_{CC}$ ) With Respect to Ground	+4.50 V to +5.50 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

### Note:

- Military products are 100% tested at  $T_c = +25^\circ\text{C}$ ,  $+125^\circ\text{C}$ , and  $-55^\circ\text{C}$ .

## DC CHARACTERISTICS over MILITARY operating ranges unless otherwise specified (Note 2)

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -2$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 12$ mA $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 3)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 3)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18$ mA, $V_{CC} = \text{Min}$		-1.2	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.4$ V, $V_{CC} = \text{Max.}$ (Note 4)		25	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4$ V, $V_{CC} = \text{Max.}$ (Note 4)		-250	$\mu\text{A}$
$I_I$	Maximum Input Current	$V_{IN} = 5.5$ V, $V_{CC} = \text{Max.}$		1	mA
$I_{ozH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 4)		100	$\mu\text{A}$
$I_{ozL}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4$ V, $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 4)		-100	$\mu\text{A}$
$I_{sc}$	Output Short-Circuit Current	$V_{OUT} = 0.5$ V, $V_{CC} = \text{Max.}$ (Note 5)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0$ V, Outputs Open ( $I_{OUT} = 0$ mA) $V_{CC} = \text{Max.}$		210	mA

### Notes:

- For APL Products, Group A, Subgroups 1, 2, and 3 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
- $V_{IL}$  and  $V_{IH}$  are input conditions of output tests and are not themselves directly tested.  $V_{IL}$  and  $V_{IH}$  are absolute voltages with respect to device ground and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.
- I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{ozL}$  (or  $I_{IH}$  and  $I_{ozH}$ ).
- Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5$  V has been chosen to avoid test problems caused by tester ground degradation.

### CAPACITANCE (Note 1)

Parameter Symbol	Parameter Descriptions	Test Conditions		Typ.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 2.0 V	V <sub>CC</sub> = 5.0 V T <sub>A</sub> = +25°C	9	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 2.0 V	f = 1 MHz	10	

**Note:**

1. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

### SWITCHING CHARACTERISTICS over MILITARY operating ranges (Note 2)

Parameter Symbol	Parameter Description		-10		-12		Unit		
			Min. (Note 3)	Max.	Min. (Note 3)	Max.			
t <sub>PD</sub>	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4	3	10	3	12	ns	
t <sub>S</sub>	Setup Time from Input or Feedback to Clock		20R8, 20R6, 20R4	10		12		ns	
t <sub>H</sub>	Hold Time			0		0		ns	
t <sub>CO</sub>	Clock to Output			3	10	3	12	ns	
t <sub>SKEW</sub>	Skew Between Registered Outputs (Note 4)				1		1	ns	
t <sub>WL</sub>	Clock Width	LOW		8		10		ns	
t <sub>WH</sub>		HIGH		8		10		ns	
f <sub>MAX</sub>	Maximum Frequency (Note 5)	External Feedback		1/(t <sub>S</sub> + t <sub>CO</sub> )	50		41.7		MHz
		Internal Feedback (f <sub>CNT</sub> )		62.5		50		MHz	
		No Feedback		1/(t <sub>WH</sub> + t <sub>WL</sub> )	62.5		50		MHz
t <sub>PXZ</sub>	$\overline{OE}$ to Output Enable (Note 5)			20L8, 20R6, 20R4	3	12	3	15	ns
t <sub>XPZ</sub>	$\overline{OE}$ to Output Disable (Note 5)		3		12	3	15	ns	
t <sub>EA</sub>	Input to Output Enable Using Product Term Control (Note 5)		20L8, 20R6, 20R4	3	12	3	15	ns	
t <sub>ER</sub>	Input to Output Disable Using Product Term Control (Note 5)			3	12	3	15	ns	

**Notes:**

2. See Switching Test Circuit for test conditions. For APL products Group A, Subgroups 9, 10, and 11 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
3. Minimum value for t<sub>PD</sub>, t<sub>CO</sub>, t<sub>PXZ</sub>, t<sub>XPZ</sub>, t<sub>EA</sub>, and t<sub>ER</sub> parameters should be used for simulation purposes only and are not tested.
4. Skew is measured with all outputs switching in the same direction.
5. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where these parameters may be affected.

## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-0.5 V to +5.5 V
DC Output or I/O Pin Voltage	-0.5 V to $V_{CC}$ Max.
DC Input Current	-30 mA to +5 mA

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ. Absolute Maximum Ratings are for system design reference; parameters given are not tested.

## OPERATING RANGES

### Military (M) Devices (Note 1)

Ambient Temperature ( $T_A$ ) Operating in Free Air	-55°C Min.
Operating Case ( $T_C$ ) Temperature	+125°C Max.
Supply Voltage ( $V_{CC}$ ) with Respect to Ground	+4.50 V to +5.50 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

### Note:

1. Military products are tested at  $T_C = +25^\circ\text{C}$ ,  $+125^\circ\text{C}$ , and  $-55^\circ\text{C}$  per MIL-STD-883.

## DC CHARACTERISTICS over MILITARY operating ranges unless otherwise specified (Note 2)

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -2 \text{ mA}$ $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$	2.4		V
$V_{OL}$	Output LOW Voltage	$I_{OL} = 12 \text{ mA}$ $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{CC} = \text{Min.}$		0.5	V
$V_{IH}$	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 3)	2.0		V
$V_{IL}$	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 3)		0.8	V
$V_I$	Input Clamp Voltage	$I_{IN} = -18 \text{ mA}$ , $V_{CC} = \text{Min.}$		-1.5	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.4 \text{ V}$ , $V_{CC} = \text{Max.}$ (Note 4)		25	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{IN} = 0.4 \text{ V}$ , $V_{CC} = \text{Max.}$ (Note 4)		-250	$\mu\text{A}$
$I_I$	Maximum Input Current	$V_{IN} = 5.5 \text{ V}$ , $V_{CC} = \text{Max.}$		100	$\mu\text{A}$
$I_{OZH}$	Off-State Output Leakage Current HIGH	$V_{OUT} = 2.7 \text{ V}$ , $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 4)		100	$\mu\text{A}$
$I_{OZL}$	Off-State Output Leakage Current LOW	$V_{OUT} = 0.4 \text{ V}$ , $V_{CC} = \text{Max.}$ $V_{IN} = V_{IH}$ or $V_{IL}$ (Note 4)		-100	$\mu\text{A}$
$I_{SC}$	Output Short-Circuit Current	$V_{OUT} = 0.5 \text{ V}$ , $V_{CC} = \text{Max.}$ (Note 5)	-30	-130	mA
$I_{CC}$	Supply Current	$V_{IN} = 0 \text{ V}$ , Outputs Open ( $I_{OUT} = 0 \text{ mA}$ ) $V_{CC} = \text{Max.}$		210	mA

### Notes:

2. For APL Products, Group A, Subgroups 1, 2, and 3 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
3.  $V_{IL}$  and  $V_{IH}$  are input conditions of output tests and are not themselves directly tested.  $V_{IL}$  and  $V_{IH}$  are absolute voltages with respect to device ground and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.
4. I/O pin leakage is the worst case of  $I_{IL}$  and  $I_{OZL}$  (or  $I_{IH}$  and  $I_{OZH}$ ).
5. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.  $V_{OUT} = 0.5 \text{ V}$  has been chosen to avoid test problems caused by tester ground degradation.

### CAPACITANCE (Note 1)

Parameter Symbol	Parameter Description	Test Conditions			Typ.	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 2.0 V	V <sub>CC</sub> = 5.0 V T <sub>A</sub> = 25°C	CLK, $\overline{\text{OE}}$	12	pF
				Other Inputs	7	
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 2.0 V	f = 1 MHz	Outputs	8	

**Note:**

1. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

### SWITCHING CHARACTERISTICS over MILITARY operating ranges (Note 2)

Parameter Symbol	Parameter Description		Min. (Note 3)	Max.	Unit		
t <sub>PD</sub>	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4	3	15	ns	
t <sub>S</sub>	Setup Time from Input or Feedback to Clock		20R8, 20R6, 20R4	15		ns	
t <sub>H</sub>	Hold Time			0		ns	
t <sub>CO</sub>	Clock to Output			2	13	ns	
t <sub>WL</sub>	Clock Width	LOW		10		ns	
t <sub>WH</sub>		HIGH		10		ns	
f <sub>MAX</sub>	Maximum Frequency (Note 5)	External Feedback		1/(t <sub>S</sub> + t <sub>CO</sub> )	35.7		MHz
		Internal Feedback (f <sub>CNT</sub> )		37		MHz	
		No Feedback		1/(t <sub>WH</sub> + t <sub>WL</sub> )	50		MHz
t <sub>PZX</sub>	$\overline{\text{OE}}$ to Output Enable (Note 6)				1	15	ns
t <sub>PXZ</sub>	$\overline{\text{OE}}$ to Output Disable (Note 6)				1	15	ns
t <sub>EA</sub>	Input to Output Enable Using Product Term Control (Note 6)		20L8, 20R6, 20R4	3	15	ns	
t <sub>ER</sub>	Input to Output Disable Using Product Term Control (Note 6)			3	15	ns	

**Notes:**

2. See Switching Test Circuit for test conditions. For APL products Group A, Subgroups 9, 10, and 11 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
3. Minimum value for t<sub>PD</sub>, t<sub>CO</sub>, t<sub>PZX</sub>, t<sub>PXZ</sub>, t<sub>EA</sub>, and t<sub>ER</sub> parameters should be used for simulation purposes only and are not tested.
4. Calculated from measured f<sub>MAX</sub> internal.
5. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.
6. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where these parameters may be affected.

## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.5 V to +5.5 V
DC Output or I/O Pin Voltage	5.5 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ. Absolute Maximum Ratings are for system design reference; parameters given are not tested.

## OPERATING RANGES

### Military (M) Devices (Note 1)

Ambient Temperature (T <sub>A</sub> ) Operating in Free Air	-55°C Min.
Operating Case (T <sub>c</sub> ) Temperature	+125°C Max.
Supply Voltage (V <sub>cc</sub> ) with Respect to Ground	+4.50 V to +5.50 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

### Note:

1. Military products are tested at T<sub>c</sub> = +25°C, +125°C, and -55°C per MIL-STD-883.

## DC CHARACTERISTICS over MILITARY operating ranges unless otherwise specified (Note 2)

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = -2 mA V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>CC</sub> = Min.	2.4		V
V <sub>OL</sub>	Output LOW Voltage	I <sub>OL</sub> = 12 mA V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>CC</sub> = Min.		0.5	V
V <sub>IH</sub>	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 3)	2.0		V
V <sub>IL</sub>	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 3)		0.8	V
V <sub>I</sub>	Input Clamp Voltage	I <sub>IN</sub> = -18 mA, V <sub>CC</sub> = Min.		-1.5	V
I <sub>IH</sub>	Input HIGH Current	V <sub>IN</sub> = 2.4 V, V <sub>CC</sub> = Max. (Note 4)		25	μA
I <sub>IL</sub>	Input LOW Current	V <sub>IN</sub> = 0.4 V, V <sub>CC</sub> = Max. (Note 4)		-250	μA
I <sub>I</sub>	Maximum Input Current	V <sub>IN</sub> = 5.5 V, V <sub>CC</sub> = Max.		1	mA
I <sub>ozH</sub>	Off-State Output Leakage Current HIGH	V <sub>OUT</sub> = 2.4 V, V <sub>CC</sub> = Max. V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> (Note 4)		100	μA
I <sub>ozL</sub>	Off-State Output Leakage Current LOW	V <sub>OUT</sub> = 0.4 V, V <sub>CC</sub> = Max. V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> (Note 4)		-100	μA
I <sub>sc</sub>	Output Short-Circuit Current	V <sub>OUT</sub> = 0.5 V, V <sub>CC</sub> = Max. (Note 5)	-30	-130	mA
I <sub>cc</sub>	Supply Current	V <sub>IN</sub> = 0 V, Outputs Open (I <sub>OUT</sub> = 0 mA) V <sub>CC</sub> = Max.		210	mA

### Notes:

2. For APL Products, Group A, Subgroups 1, 2, and 3 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
3. V<sub>IL</sub> and V<sub>IH</sub> are input conditions of output tests and are not themselves directly tested. V<sub>IL</sub> and V<sub>IH</sub> are absolute voltages with respect to device ground and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.
4. I/O pin leakage is the worst case of I<sub>IL</sub> and I<sub>ozL</sub> (or I<sub>IH</sub> and I<sub>ozH</sub>).
5. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second. V<sub>OUT</sub> = 0.5 V has been chosen to avoid test problems caused by tester ground degradation.

**SWITCHING CHARACTERISTICS over MILITARY operating ranges (Note 1)**

Parameter Symbol	Parameter Description		Min.	Max.	Unit
t <sub>PD</sub>	Input or Feedback to Combinatorial Output			20	ns
t <sub>S</sub>	Setup Time from Input or Feedback to Clock		20		ns
t <sub>H</sub>	Hold Time		0		ns
t <sub>CO</sub>	Clock to Output or Feedback			15	ns
t <sub>WL</sub>	Clock Width	LOW	12		ns
t <sub>WH</sub>		HIGH	12		ns
f <sub>MAX</sub>	Maximum Frequency (Note 2)	External Feedback	1/(t <sub>S</sub> + t <sub>CO</sub> )		MHz
		No Feedback	1/(t <sub>WH</sub> + t <sub>WL</sub> )		MHz
t <sub>PZX</sub>	OE to Output Enable (Note 3)			20	ns
t <sub>PXZ</sub>	OE to Output Disable (Note 3)			20	ns
t <sub>EA</sub>	Input to Output Enable Using Product Term Control (Note 3)			25	ns
t <sub>ER</sub>	Input to Output Disable Using Product Term Control (Note 3)			20	ns

**Notes:**

1. See Switching Test Circuit for test conditions. For APL products Group A, Subgroups 9, 10, and 11 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
2. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.
3. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where these parameters may be affected.



## ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-55°C to +125°C
Supply Voltage with Respect to Ground	-0.5 V to +7.0 V
DC Input Voltage	-1.5 V to +5.5 V
DC Output or I/O Pin Voltage	5.5 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ. Absolute Maximum Ratings are for system design reference; parameters given are not tested.

## OPERATING RANGES

### Military (M) Devices (Note 1)

Ambient Temperature (T <sub>A</sub> ) Operating in Free Air	-55°C Min.
Operating Case (T <sub>C</sub> ) Temperature	+125°C Max.
Supply Voltage (V <sub>CC</sub> ) with Respect to Ground	+4.50 V to +5.50 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

### Note:

1. Military products are tested at T<sub>C</sub> = +25°C, +125°C, and -55°C per MIL-STD-883.

## DC CHARACTERISTICS over MILITARY operating ranges unless otherwise specified (Note 2)

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = -2 mA V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>CC</sub> = Min.	2.4		V
V <sub>OL</sub>	Output LOW Voltage	I <sub>OL</sub> = 12 mA V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>CC</sub> = Min.		0.5	V
V <sub>IH</sub>	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 3)	2.0		V
V <sub>IL</sub>	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 3)		0.8	V
V <sub>I</sub>	Input Clamp Voltage	I <sub>IN</sub> = -18 mA, V <sub>CC</sub> = Min.		-1.5	V
I <sub>IH</sub>	Input HIGH Current	V <sub>IN</sub> = 2.4 V, V <sub>CC</sub> = Max. (Note 4)		25	μA
I <sub>IL</sub>	Input LOW Current	V <sub>IN</sub> = 0.4 V, V <sub>CC</sub> = Max. (Note 4)		-250	μA
I <sub>I</sub>	Maximum Input Current	V <sub>IN</sub> = 5.5 V, V <sub>CC</sub> = Max.		1	mA
I <sub>ozH</sub>	Off-State Output Leakage Current HIGH	V <sub>OUT</sub> = 2.4 V, V <sub>CC</sub> = Max. V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> (Note 4)		100	μA
I <sub>ozL</sub>	Off-State Output Leakage Current LOW	V <sub>OUT</sub> = 0.4 V, V <sub>CC</sub> = Max. V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> (Note 4)		-100	μA
I <sub>sc</sub>	Output Short-Circuit Current	V <sub>OUT</sub> = 0.5 V, V <sub>CC</sub> = Max. (Note 5)	-30	-130	mA
I <sub>CC</sub>	Supply Current	V <sub>IN</sub> = 0 V, Outputs Open (I <sub>OUT</sub> = 0 mA) V <sub>CC</sub> = Max.		210	mA

### Notes:

2. For APL Products, Group A, Subgroups 1, 2, and 3 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
3. V<sub>IL</sub> and V<sub>IH</sub> are input conditions of output tests and are not themselves directly tested. V<sub>IL</sub> and V<sub>IH</sub> are absolute voltages with respect to device ground and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.
4. I/O pin leakage is the worst case of I<sub>IL</sub> and I<sub>ozL</sub> (or I<sub>IH</sub> and I<sub>ozH</sub>).
5. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second. V<sub>OUT</sub> = 0.5 V has been chosen to avoid test problems caused by tester ground degradation.



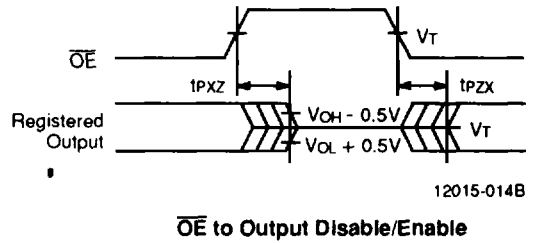
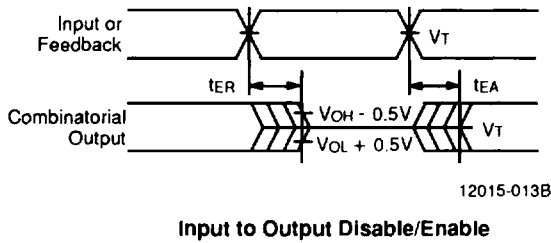
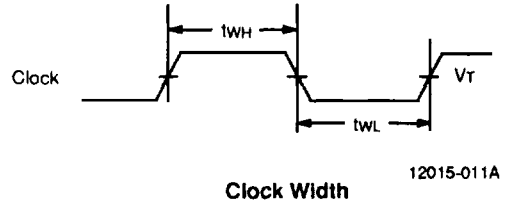
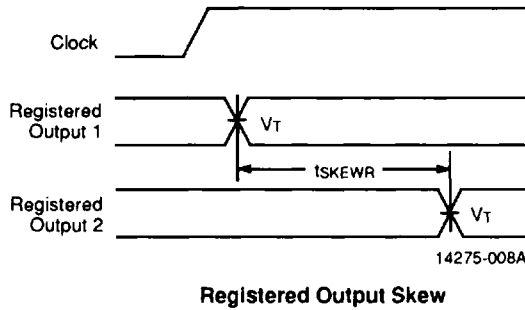
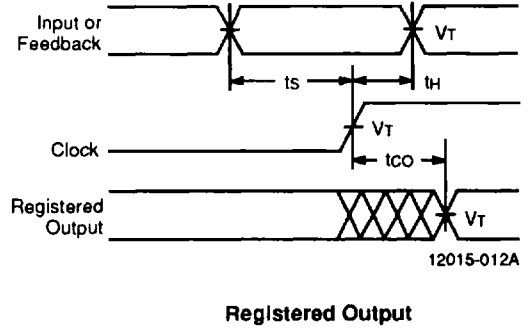
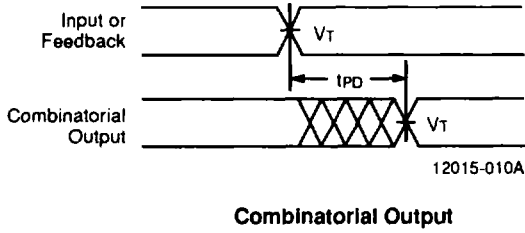
**SWITCHING CHARACTERISTICS over MILITARY operating ranges (Note 1)**

Parameter Symbol	Parameter Description		Min.	Max.	Unit
t <sub>PD</sub>	Input or Feedback to Combinatorial Output			30	ns
t <sub>s</sub>	Setup Time from Input or Feedback to Clock		30		ns
t <sub>H</sub>	Hold Time		0		ns
t <sub>CO</sub>	Clock to Output or Feedback			20	ns
t <sub>WL</sub>	Clock Width	LOW	20		ns
t <sub>WH</sub>		HIGH	20		ns
f <sub>MAX</sub>	Maximum Frequency (Note 2)	External Feedback	1/(t <sub>s</sub> + t <sub>CO</sub> )		MHz
		No Feedback	1/(t <sub>WH</sub> + t <sub>WL</sub> )		MHz
t <sub>PZX</sub>	$\overline{OE}$ to Output Enable (Note 3)			25	ns
t <sub>PXZ</sub>	$\overline{OE}$ to Output Disable (Note 3)			25	ns
t <sub>EA</sub>	Input to Output Enable Using Product Term Control (Note 3)			30	ns
t <sub>ER</sub>	Input to Output Disable Using Product Term Control (Note 3)			30	ns

**Notes:**

1. See Switching Test Circuit for test conditions. For APL products Group A, Subgroups 9, 10, and 11 are tested per MIL-STD-883, Method 5005, unless otherwise noted.
2. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.
3. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where these parameters may be affected.

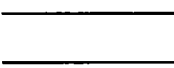

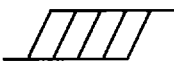

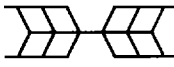
**SWITCHING WAVEFORMS**



**Notes:**

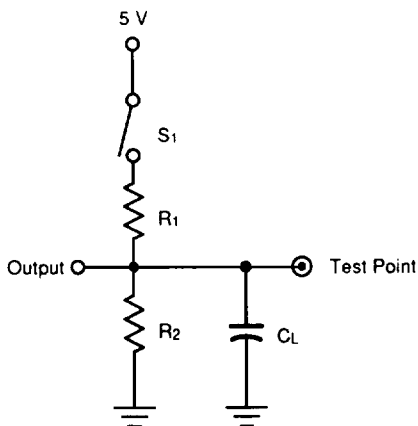
1.  $V_T = 1.5\text{ V}$
2. Input pulse amplitude 0 V to 3.0 V
3. Input rise and fall times 2–3 ns typical.

## KEY TO SWITCHING WAVEFORMS

WAVEFORM	INPUTS	OUTPUTS
	Must be Steady	Will be Steady
	May Change from H to L	Will be Changing from H to L
	May Change from L to H	Will be Changing from L to H
	Don't Care, Any Change Permitted	Changing, State Unknown
	Does Not Apply	Center Line is High-Impedance "Off" State

KS000010-PAL

## SWITCHING TEST CIRCUIT

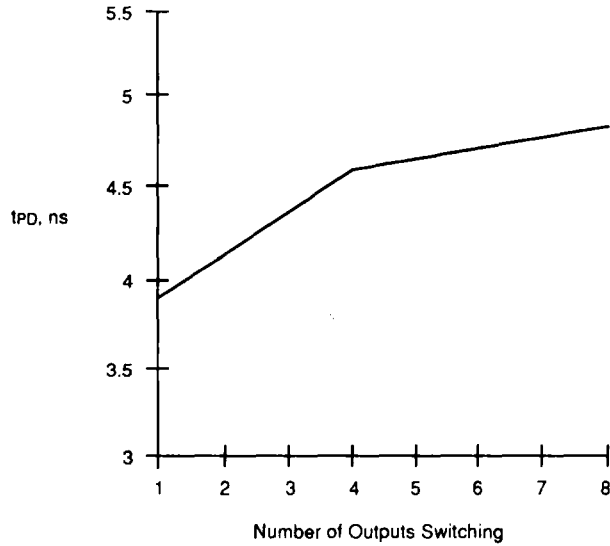


12350-019A

Specification	S <sub>1</sub>	C <sub>L</sub>	Commercial		Measured Output Value
			R <sub>1</sub>	R <sub>2</sub>	
t <sub>PD</sub> , t <sub>CO</sub>	Closed	50 pF	200 Ω	200 Ω	1.5 V
t <sub>PZX</sub> , t <sub>EA</sub>	Z → H: Open Z → L: Closed				1.5 V
t <sub>PXZ</sub> , t <sub>ER</sub>	H → Z: Open L → Z: Closed	5 pF			H → Z: V <sub>OH</sub> - 0.5 V L → Z: V <sub>OL</sub> + 0.5 V

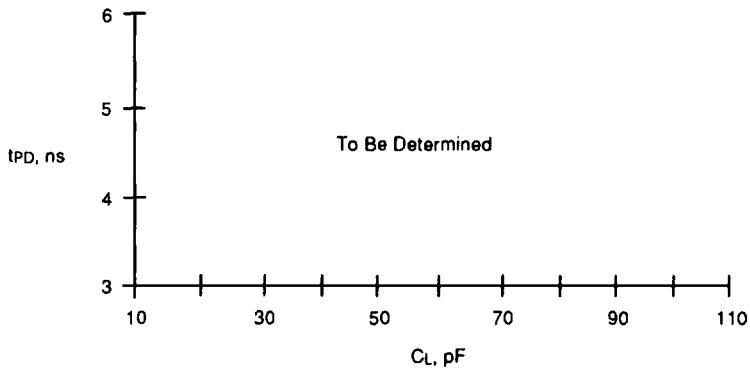
**MEASURED SWITCHING CHARACTERISTICS FOR THE PAL20R8-5**

$V_{CC} = 4.75\text{ V}$ ,  $T_A = 75^\circ\text{C}$  (Note 1)



**t<sub>PD</sub> vs. Number of Outputs Switching**

10294-005B



**t<sub>PD</sub> vs. Load Capacitance**

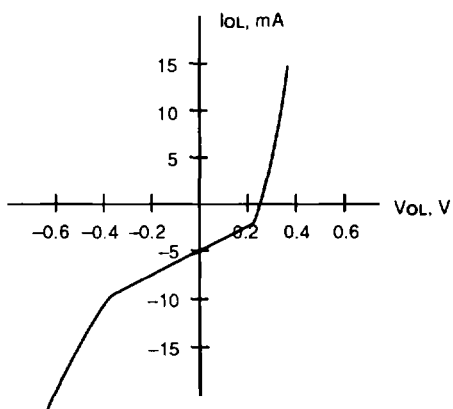
10294-006A

**Note:**

1. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where t<sub>PD</sub> may be affected.

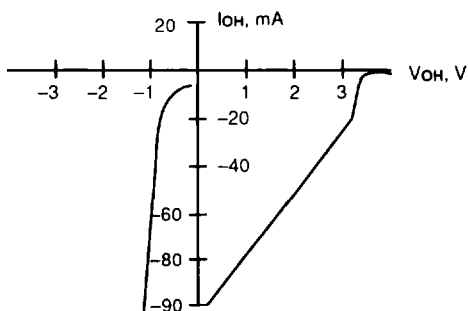
**CURRENT VS. VOLTAGE (I-V) CHARACTERISTICS FOR THE PAL20R8-5**

$V_{CC} = 5.0 \text{ V}$ ,  $T_A = 25^\circ\text{C}$



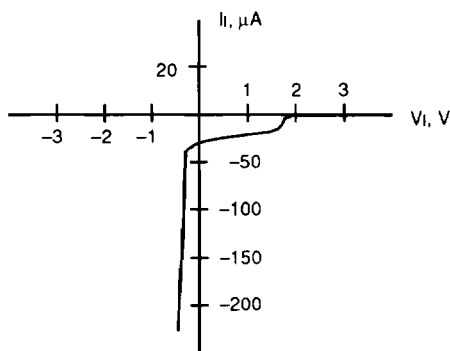
**Output, LOW**

10240-003B



**Output, HIGH**

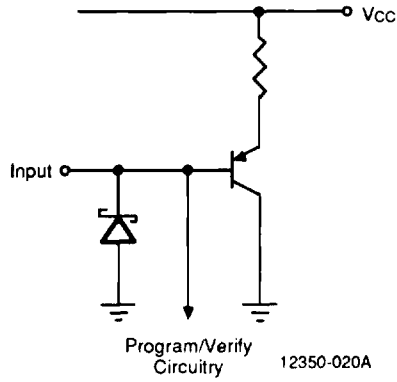
10240-004B



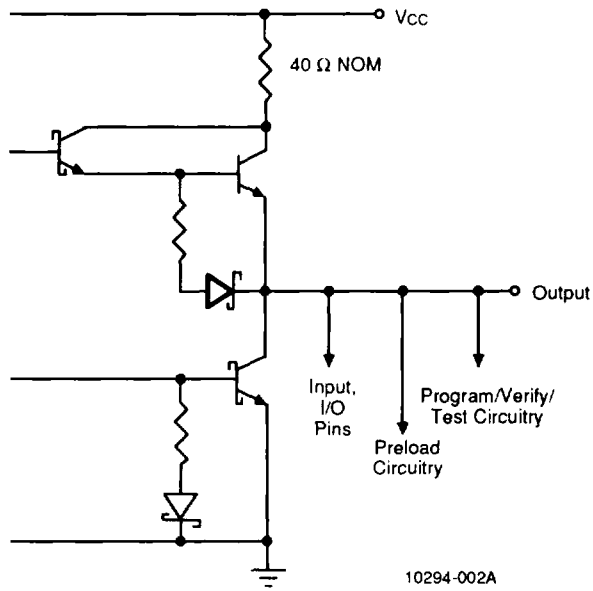
**Input**

10240-005A

INPUT/OUTPUT EQUIVALENT SCHEMATICS



Typical Input



Typical Output

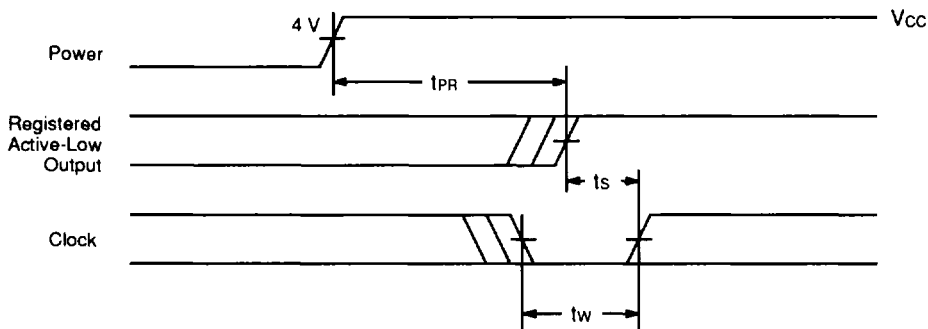
## POWER-UP RESET

The power-up reset feature ensures that all flip-flops will be reset to LOW after the device has been powered up. The output state will be HIGH due to the inverting output buffer. This feature is valuable in simplifying state machine initialization. A timing diagram and parameter table are shown below. Due to the synchronous operation of the power-up reset and the wide range of ways  $V_{CC}$

can rise to its steady state, two conditions are required to ensure a valid power-up reset. These conditions are:

1. The  $V_{CC}$  rise must be monotonic.
2. Following reset, the clock input must not be driven from LOW to HIGH until all applicable input and feedback setup times are met.

Parameter Symbol	Parameter Description	Max.	Unit
$t_{PR}$	Power-up Reset Time	1000	ns
$t_s$	Input or Feedback Setup Time	See Switching Characteristics	
$t_{wL}$	Clock Width LOW		



12350-024A

Power-Up Reset Waveform